

# FAN1086

## 1.5A Adjustable/Fixed Low Dropout Linear Regulator

### Features

- Low dropout voltage
- Load regulation: 0.05% typical
- Trimmed current limit
- On-chip thermal limiting
- Standard SOT-223, TO-263, and TO-252 packages
- Three-terminal adjustable or fixed 2.5V, 2.85V, 3.3V, 5V

### Applications

- Active SCSI terminators
- High efficiency linear regulators
- Post regulators for switching supplies
- Battery chargers
- 5V to 3.3V linear regulators
- Motherboard clock supplies

### Description

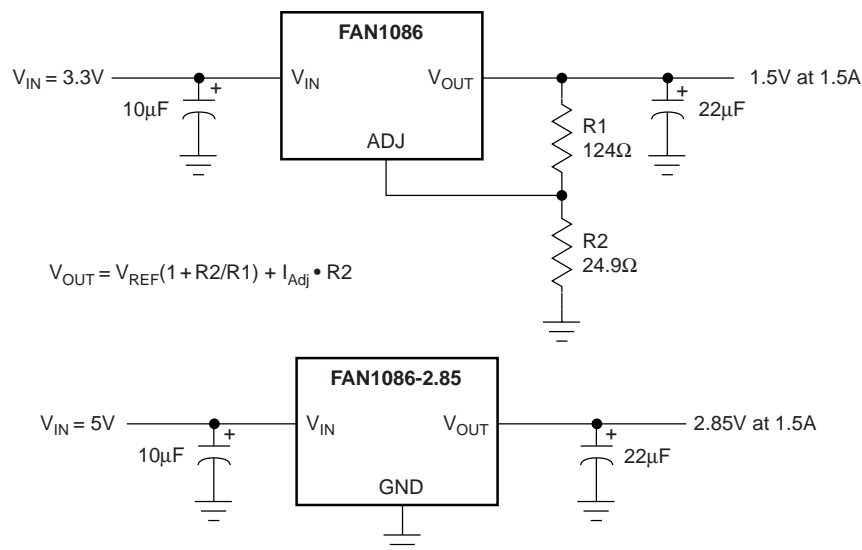
The FAN1086 and FAN1086-2.5, -2.85, -3.3 and -5 are low dropout three-terminal regulators with 1.5A output current capability. These devices have been optimized for low voltage where transient response and minimum input voltage are critical. The 2.85V version is designed specifically to be used in Active Terminators for SCSI bus.

Current limit is trimmed to ensure specified output current and controlled short-circuit current. On-chip thermal limiting provides protection against any combination of overload and ambient temperatures that would create excessive junction temperatures.

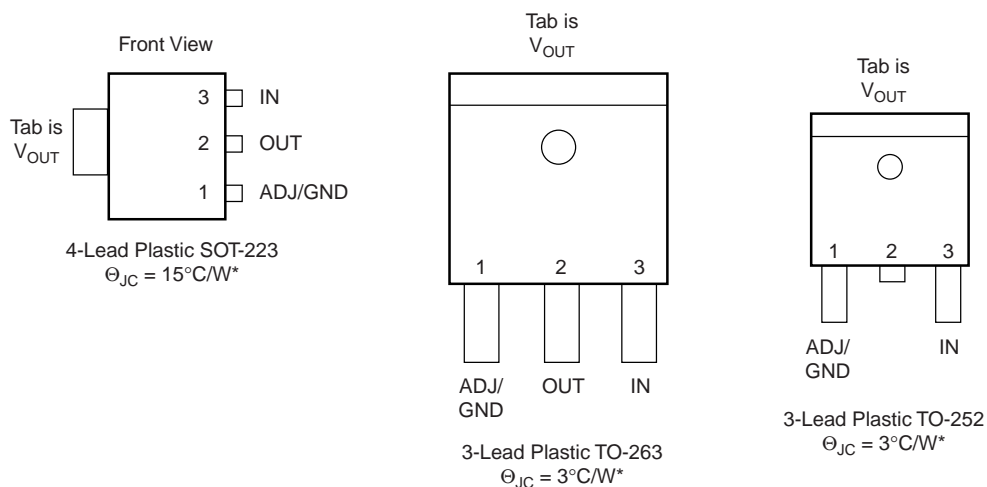
Unlike PNP type regulators where up to 10% of the output current is wasted as quiescent current, the quiescent current of the FAN1086 flows into the load, increasing efficiency.

The FAN1086 series regulators are available in the industry-standard SOT-223, TO-263, and TO-252 power packages.

### Typical Applications



## Pin Assignments



\*With package soldered to 0.5 square inch copper area over backside ground plane or internal power plane,  $\theta_{JA}$  can vary from  $30^{\circ}\text{C/W}$  to more than  $50^{\circ}\text{C/W}$ . Other mounting techniques may provide better thermal resistance than  $30^{\circ}\text{C/W}$ .

## Absolute Maximum Ratings

Parameter	Min.	Max.	Unit
$V_{IN}$		7.5	V
Operating Junction Temperature Range	0	125	$^{\circ}\text{C}$
Storage Temperature Range	-65	150	$^{\circ}\text{C}$
Lead Temperature (Soldering, 10 sec.)		300	$^{\circ}\text{C}$

## Electrical Characteristics

Operating Conditions:  $V_{IN} \leq 7V$ ,  $T_J = 25^\circ C$  unless otherwise specified.

The • denotes specifications which apply over the specified operating temperature range.

Parameter	Conditions	Min.	Typ.	Max.	Units
Reference Voltage <sup>3</sup> , $V_{REF}$	$1.5V \leq (V_{IN} - V_{OUT}) \leq 5.75V$ , $10mA \leq I_{OUT} \leq 1A$	• 1.225 (-2%)	1.250	1.275 (+2%)	V
Output Voltage	$10mA \leq I_{OUT} \leq 1A$ FAN1086-2.5, $4V \leq V_{IN} \leq 7V$ FAN1086-2.85, $4.35V \leq V_{IN} \leq 7V$ FAN1086-3.3, $4.8V \leq V_{IN} \leq 7V$ FAN1086-5, $6.5V \leq V_{IN} \leq 7V$	• 2.450 • 2.793 • 3.234 • 4.900	2.5 2.85 3.3 5.0	2.550 2.907 3.366 5.100	V V V V
Line Regulation <sup>1,2</sup>	$(V_{OUT} + 1.5V) \leq V_{IN} \leq 7V$ , $I_{OUT} = 10mA$	•	0.005	0.2	%
Load Regulation <sup>1,2</sup>	$(V_{IN} - V_{OUT}) = 2V$ , $10mA \leq I_{OUT} \leq 1A$	•	0.05	0.5	%
Dropout Voltage	$\Delta V_{REF} = 1\%$ , $I_{OUT} = 1.5A$	•	1.300	1.500	V
Current Limit	$(V_{IN} - V_{OUT}) = 2V$	• 1.6	2.0		A
Adjust Pin Current <sup>3</sup> , $I_{Adj}$		•	35	120	$\mu A$
Adjust Pin Current Change <sup>3</sup>	$1.5V \leq (V_{IN} - V_{OUT}) \leq 5.75$ , $10mA \leq I_{OUT} \leq 1A$	•	0.2	5	$\mu A$
Minimum Load Current	$1.5V \leq (V_{IN} - V_{OUT}) \leq 5.75$	• 10			mA
Quiescent Current	$V_{IN} = V_{OUT} + 1.25V$	•	4	13	mA
Ripple Rejection	$f = 120Hz$ , $C_{OUT} = 22\mu F$ Tantalum, $(V_{IN} - V_{OUT}) = 3V$ , $I_{OUT} = 1.5A$		60	72	dB
Thermal Regulation	$T_A = 25^\circ C$ , 30ms pulse		0.004	0.02	%/W
Temperature Stability		•	0.5		%
Long-Term Stability	$T_A = 125^\circ C$ , 1000hrs.		0.03	1.0	%
RMS Output Noise (% of $V_{OUT}$ )	$T_A = 25^\circ C$ , $10Hz \leq f \leq 10kHz$		0.003		%
Thermal Resistance, Junction to Case	SOT-223		15		$^\circ C/W$
	TO-263, TO-252		3		$^\circ C/W$
Thermal Shutdown	Junction Temperature		155		$^\circ C$
Thermal Shutdown Hysteresis			10		$^\circ C$

### Notes:

1. See thermal regulation specifications for changes in output voltage due to heating effects. Load and line regulation are measured at a constant junction temperature by low duty cycle pulse testing.
2. Line and load regulation are guaranteed up to the maximum power dissipation. Power dissipation is determined by input/output differential and the output current. Guaranteed maximum output power will not be available over the full input/output voltage range.
3. FAN1086 only.

# Typical Performance Characteristics

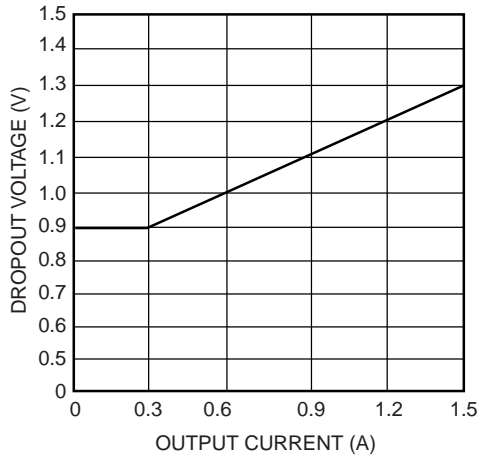


Figure 1. Dropout Voltage vs. Output Current

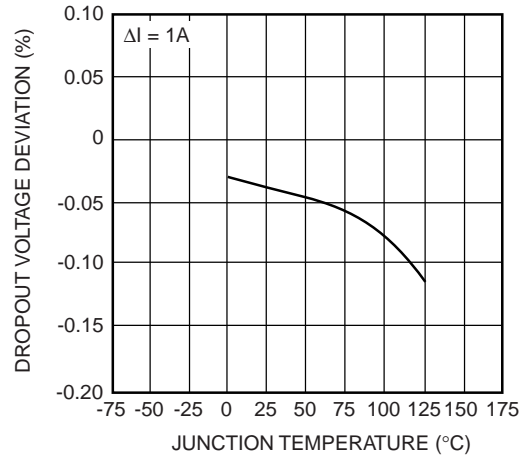


Figure 2. Load Regulation vs. Temperature

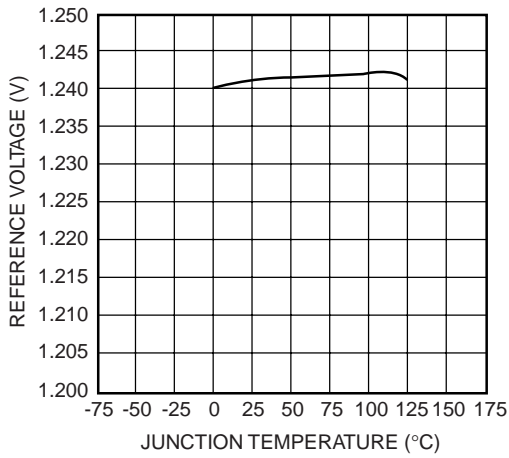


Figure 3. Reference Voltage vs. Temperature

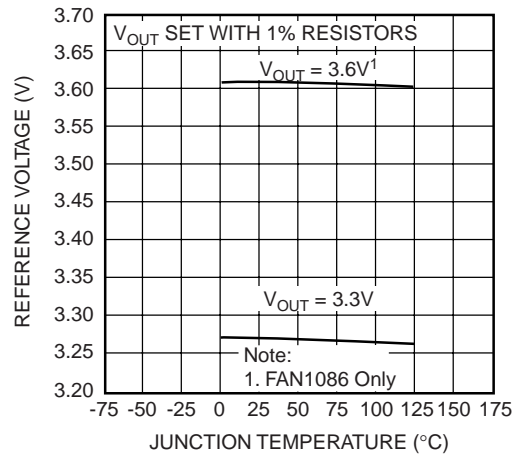


Figure 4. Output Voltage vs. Temperature

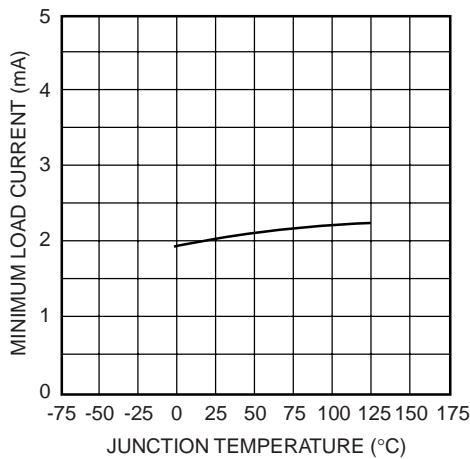


Figure 5. Minimum Load Current vs. Temperature

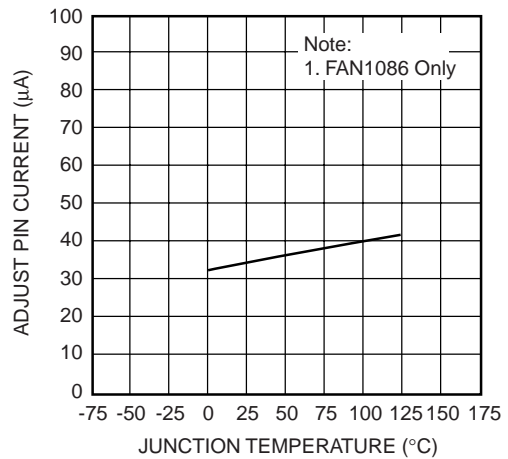


Figure 6. Adjust Pin Current vs. Temperature

Typical Performance Characteristics (continued)

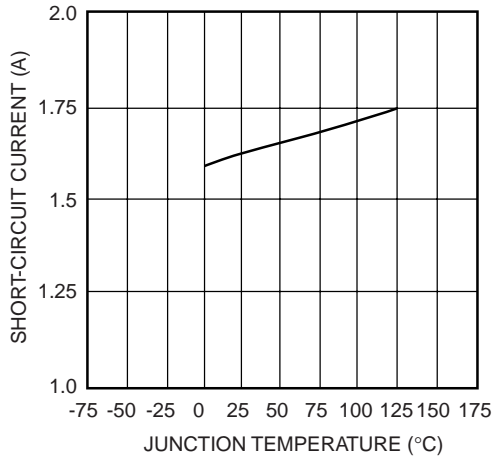


Figure 7. Short-Circuit Current vs. Temperature

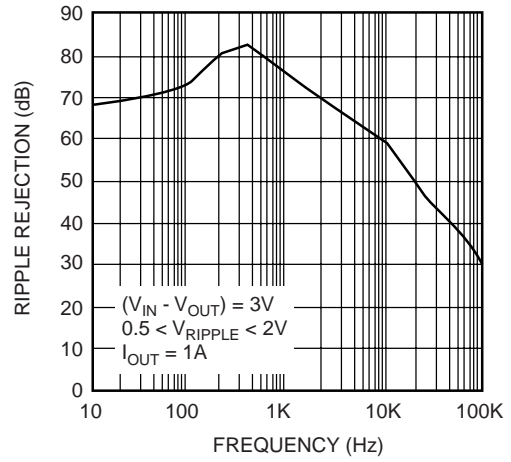


Figure 8. Ripple Rejection vs. Frequency

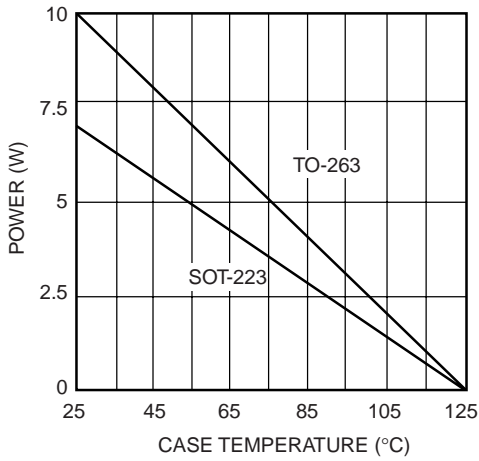


Figure 9. Maximum Power Dissipation

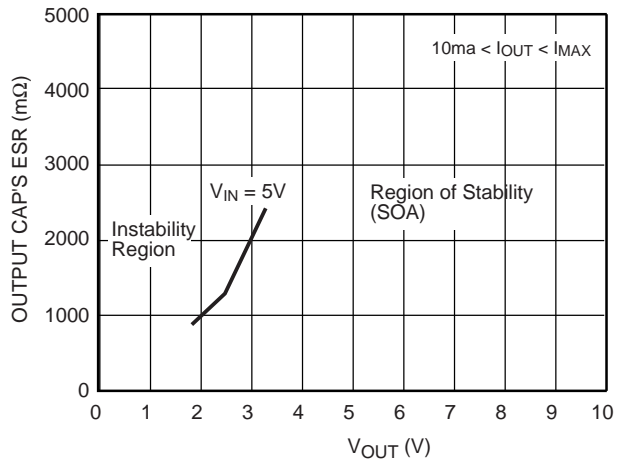


Figure 11. Stability Region (SOA) vs. ESR of the C<sub>OUT</sub>

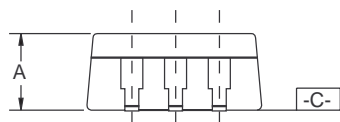
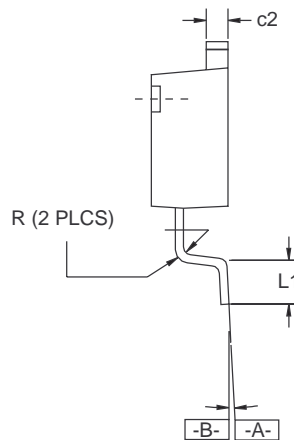
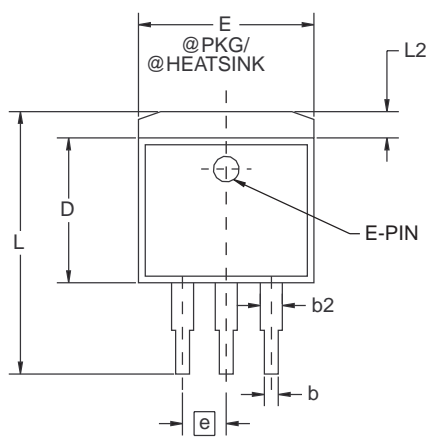
# Mechanical Dimensions

## 3-Lead TO-263 Package

Symbol	Inches		Millimeters		Notes
	Min.	Max.	Min.	Max.	
A	.160	.190	4.06	4.83	
b	.020	.036	0.51	0.91	
b2	.049	.051	1.25	1.30	
c2	.045	.055	1.14	1.40	
D	.340	.380	8.64	9.65	
E	.380	.405	9.65	10.29	
e	.100 BSC		2.54 BSC		
L	.575	.625	14.61	15.88	
L1	.090	.110	2.29	2.79	
L2	—	.055	—	1.40	
R	.017	.019	0.43	0.78	
$\alpha$	0°	8°	0°	8°	

**Notes:**

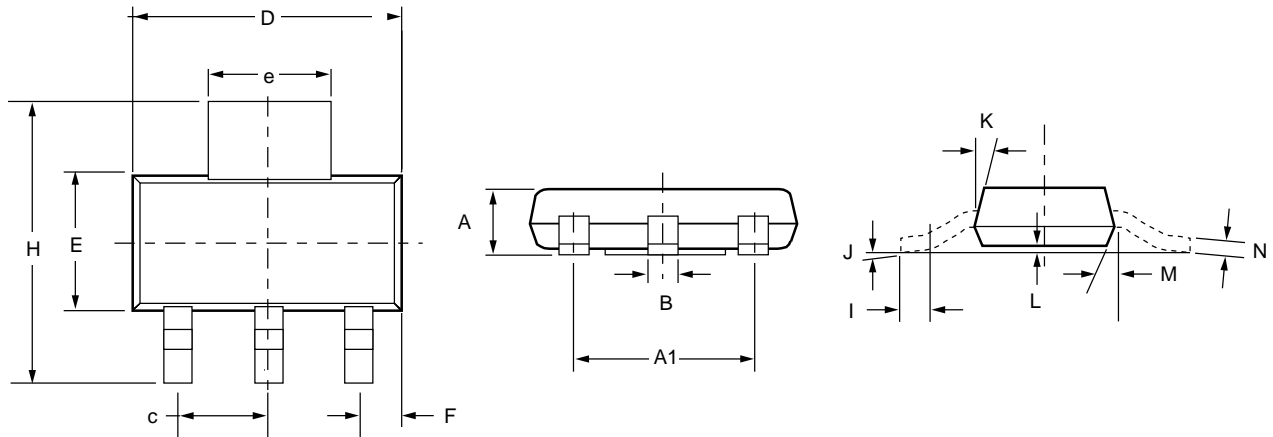
1. Dimensions are exclusive of mold flash and metal burrs.
2. Standoff-height is measured from lead tip with ref. to Datum -B-.
3. Foot length is measured with ref. to Datum -A- with lead surface (at inner R).
4. Dimension exclusive of dambar protrusion or intrusion.
5. Formed leads to be planar with respect to one another at seating place -C-.



# Mechanical Dimensions

## 4-Lead SOT-223 Package

Symbol	Inches		Millimeters		Notes
	Min.	Max.	Min.	Max.	
A	—	.071	—	1.80	
A1	—	.181	—	4.80	
B	.025	.033	.640	.840	
c	—	.090	—	2.29	
D	.248	.264	6.30	6.71	
E	.130	.148	3.30	3.71	
e	.115	.124	2.95	3.15	
F	.033	.041	.840	1.04	
H	.264	.287	6.71	7.29	
I	.012	—	.310	—	
J	—	10°	—	10°	
K	10°	16°	10°	16°	
L	.0008	.0040	.0203	.1018	
M	10°	16°	10°	16°	
N	.010	.014	.250	.360	



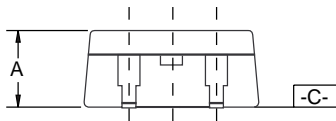
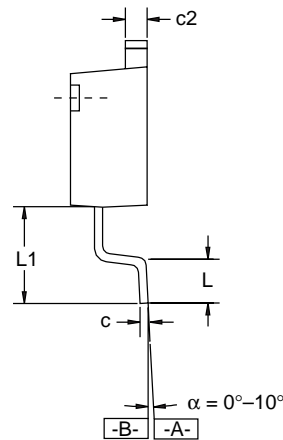
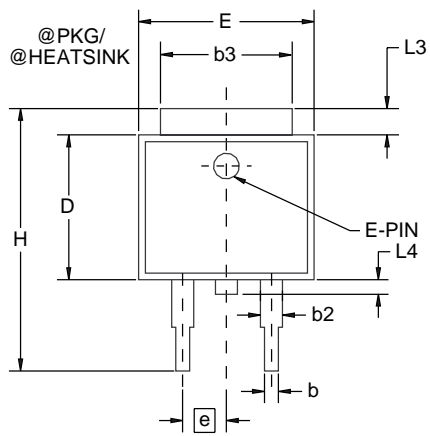
# Mechanical Dimensions

## 3-Lead TO-252 Package

Symbol	Inches		Millimeters		Notes
	Min.	Max.	Min.	Max.	
A	.086	.094	2.19	2.39	
b	.025	.035	0.64	0.89	
b2	.030	.045	0.76	1.14	
b3	.205	.215	5.21	5.46	4
c	.018	.024	0.46	0.61	
c2	.018	.023	0.46	0.58	
D	.210	.245	5.33	6.22	1
E	.250	.265	6.35	6.73	1
e	.090 BSC		2.29 BSC		
H	.370	.410	9.40	10.41	
L	.055	.070	1.40	1.78	3
L1	.108 REF		2.74 REF		
L3	.035	.080	0.89	2.03	4
L4	.025	.040	0.64	1.02	

**Notes:**

1. Dimensions are exclusive of mold flash and metal burrs.
2. Stand off-height is measured from lead tip with ref. to Datum -B-.
3. Foot length is measured with ref. to Datum -A- with lead surface.
4. Thermal pad contour optional within dimensions b3 and L3
5. Formed leads to be planar with respect to one another at seating plane -C-.
6. Dimensions and tolerances per ASME Y14.5M-1994.





## Ordering Information

Product Number	Package
FAN1086DX	TO-252
FAN1086MX	TO-263
FAN1086SX	SOT-223
FAN1086D25X	TO-252
FAN1086M25X	TO-263
FAN1086S25X	SOT-223
FAN1086D285X	TO-252
FAN1086M285X	TO-263
FAN1086S285X	SOT-223
FAN1086D33X	TO-252
FAN1086M33X	TO-263
FAN1086S33X	SOT-223
FAN1086D5X	TO-252
FAN1086M5X	TO-263
FAN1086S5X	SOT-223

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2. A critical component in any component of a life support device or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness.